MOSFET – Power, Single N-Channel 60 V, 7.2 mΩ, 67 A

NVMFS5H663NLWF – Wettable Flank Option for Enhanced Optical Inspection.

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	60	V	
Gate-to-Source Voltage	Gate-to-Source Voltage			±20	V	
Continuous Drain	Steady	T _C = 25°C	۱ _D	67	А	
Current R _{θJC} (Notes 1, 3)		$T_{C} = 100^{\circ}C$		47		
Power Dissipation	State	$T_{C} = 25^{\circ}C$	PD	63	W	
$R_{\theta JC}$ (Note 1)		T _C = 100°C		31.3	1	
Continuous Drain	Steady State	T _A = 25°C	۱ _D	16.2	А	
Current R _{θJA} (Notes 1, 2, 3)		T _A = 100°C		11.4	1	
Power Dissipation		$T_A = 25^{\circ}C$	PD	3.7	W	
R _{θJA} (Notes 1 & 2)		T _A = 100°C		1.8	1	
Pulsed Drain Current	T _A = 25	°C, t _p = 10 μs	I _{DM}	359	А	
Operating Junction and Storage Temperature			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			I _S	52	А	
Single Pulse Drain-to-Source Avalanche Energy ($I_{L(pk)} = 3.8 \text{ A}$)			E _{AS}	274	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

MAXIMUM RATINGS (T_{.1} = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	2.4	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	41	

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

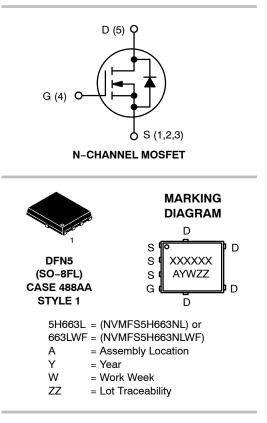
2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.



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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	7.2 m Ω @ 10 V	07.4
60 V	10 m Ω @ 4.5 V	67 A



ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

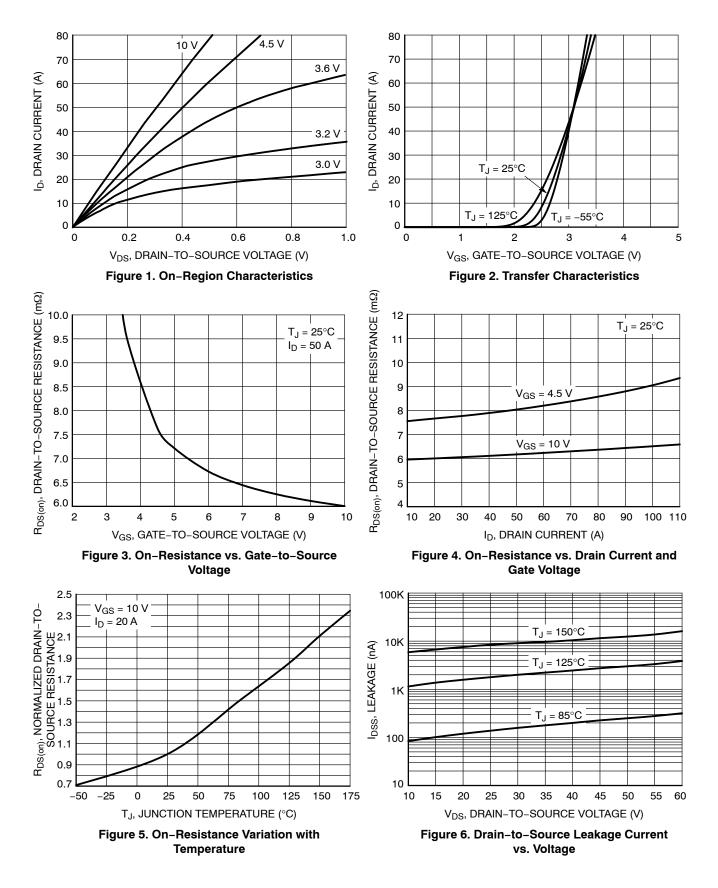
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

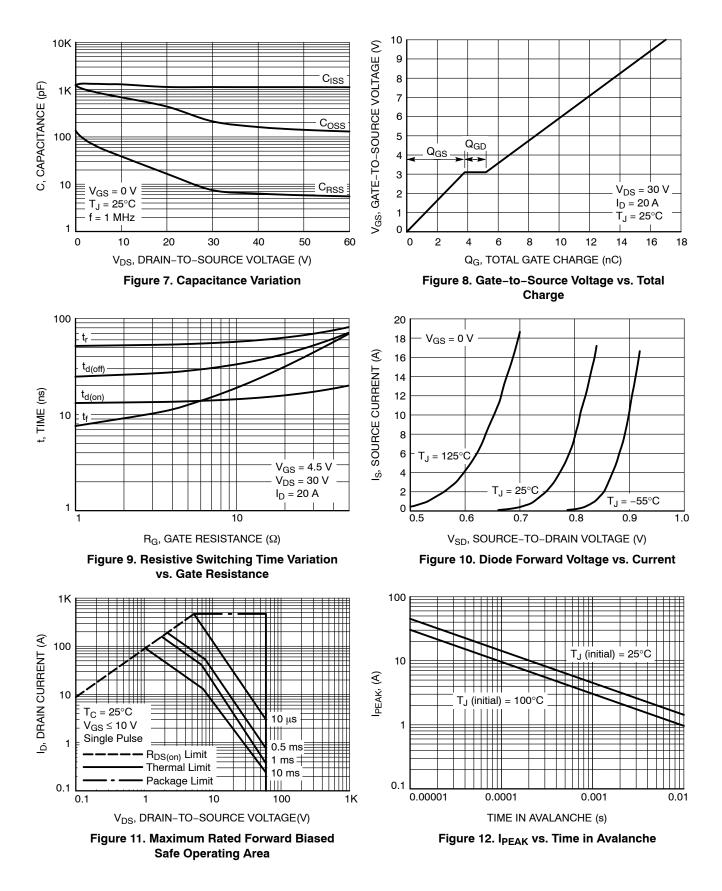
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit	
OFF CHARACTERISTICS								
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D = 250 μ A		60			V	
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				43		mV/°C	
Zero Gate Voltage Drain Current	ate Voltage Drain Current I_{DSS} V_{GS} = 0 V, T_{J} = 25	T _J = 25 °C			10	<u> </u>		
		V _{DS} = 60 V	T _J = 125°C			250	μΑ	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA	
ON CHARACTERISTICS (Note 4)								
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$, $I_D = 56 \ \mu A$		1.2		2.0	V	
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.6		mV/°	
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A		5.8	7.2		
		V_{GS} = 4.5 V	I _D = 20 A		8	10	mΩ	
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _D = 20 A			64		S	
CHARGES, CAPACITANCES & GATE RI	ESISTANCE				-	-	-	
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 30 V			1131		pF	
Output Capacitance	C _{OSS}				213			
Reverse Transfer Capacitance	C _{RSS}				7.5			
Output Charge	Q _{OSS}	$V_{GS} = 0 \text{ V}, V_{DD} = 30 \text{ V}$ $V_{GS} = 4.5 \text{ V}, V_{DS} = 30 \text{ V}; \text{ I}_{D} = 20 \text{ A}$ $V_{GS} = 10 \text{ V}, V_{DS} = 30 \text{ V}; \text{ I}_{D} = 20 \text{ A}$			18		nC	
Total Gate Charge	Q _{G(TOT)}				8			
Total Gate Charge	Q _{G(TOT)}				17			
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 30 V; I _D = 20 A			2.2			
Gate-to-Source Charge	Q _{GS}				3.8			
Gate-to-Drain Charge	Q _{GD}				1.4			
Plateau Voltage	V _{GP}				3.1		V	
SWITCHING CHARACTERISTICS (Note	5)							
Turn-On Delay Time	t _{d(ON)}				13.4		1	
Rise Time	t _r	V_{GS} = 4.5 V, V_{DS} = 48 V, I _D = 20 A, R _G = 2.5 Ω			52.7		- ns	
Turn-Off Delay Time	t _{d(OFF)}				26.2			
Fall Time	t _f				9.5			
DRAIN-SOURCE DIODE CHARACTERIS	STICS							
Forward Diode Voltage	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 20 A$	$T_J = 25^{\circ}C$		0.84	1.2	v	
			T _J = 125°C		0.70			
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 20 A			30.7		ns	
Charge Time	t _a				17.7			
Discharge Time	t _b				13.1			
Reverse Recovery Charge	Q _{RR}				22.8		nC	

performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$. 5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

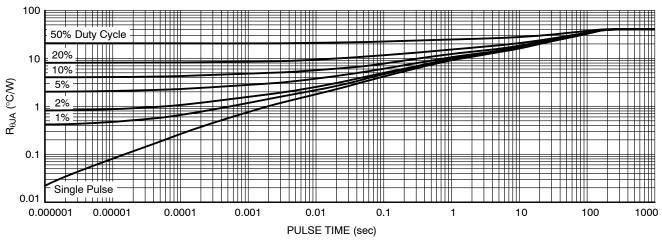


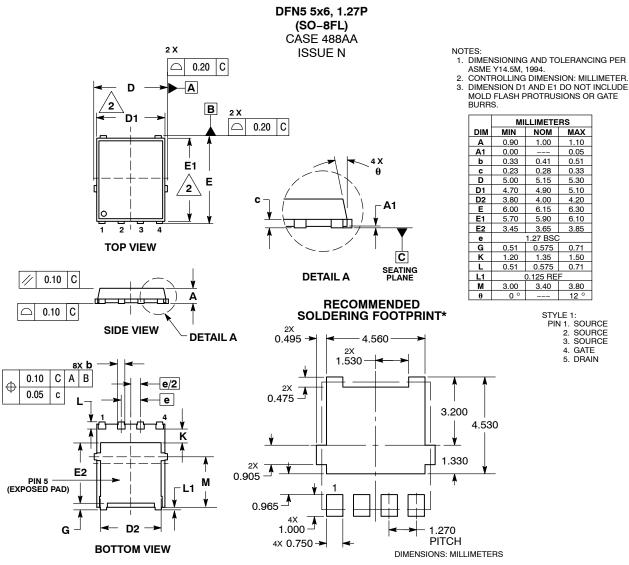
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5H663NLT1G	5H663L	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5H663NLWFT1G	663LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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